SPAR - BRAMPTON (SSS) 9445 AIRPORT RD

Critical Items List

SRMS

CIL Ref#: 2691

Revision: 0

FMEA Rev: 0

BRAMPTON ONTARIO LESAJ3

System: 5RM5

Subsystem: ELECTRICAL SUB-SYSTEM

Assembly Desc: Servo Power Amplifier

Part Number(s): 51140F1177-3

51140F1177-5

Item:

Function: Central Processing Unit Assembly

Provides hardware and software necessary to implement serve control loops, control operation of the Analog VF, Digital VF and MDA boards and communicate with the MCIU. Provides PLL and frame sync SITE as well as a hardware

watchdog timer to monitor health of microcomputer itself.

Digital Interface Assembly

Receives and loads command data to CPU. Generates position encoder clock and sync signals, processes position encoder data and external flags and assembles

return data for transmission to MCIU.

Failure Mode: Loss of CPU data to Digital Interface.

H/W Func. Screen Fallures

Criticality:

2 1R

Mission Phase: Orbit

Cause(s): Central Processing Unit Assembly

Digital Interface Assembly

CPU off-board I/O control DIGSEL1 falls inactive (high).

DIGSEL failed inactive.

Loss of ability to write into digital data FPGA.

allure effect on unit/end item:

Unable to echo data to input shift registers. Unable to update return data words RDW1 and RDW2. Tachometer data, fwd/beckdrive flag, current limit flag, BITE and BITE verification flags, motor current, EEEU BITE and shoulder brace flag are either zero or stale. Position encoder

data remains valid. ABE communication BITE.

Worst Case: Loss of mission. Loss of computer supported modes.

Redundant Paths: Direct Drive.

Backup Drive.

letention Rationale

Design:

Field Programmable Gate Arrays (FPGA's) and the Error Detection and Correction (EDAC) are semi-custom microcircuits in which the basic design functional elements are designed by the manufacturer. The interconnection of these elements is then customized by Spar to provide the functionality of the completed microcircuit. The design utilizes proven circuit techniques and is implemented using CMOS technology. This technology operates at low power and thence the device does not experience significant operating stresses. The technology is mature, and the basic device reliability is well documented. All stresses are additionally reduced by derating the appropriate parameters in accordance with SPAR-RMS-PA.003 and verified by design review.

This approach has a significant edvantage in that it reduces the quantity of discrete parts required in the assembly and also the complexity of the PWB and results in significant weight and volume savings. This type of semi-custom part has been successfully used in other space applications.

The parts are qualified to the requirements of the applicable specification. They are 100% accepted and burned in to the requirements of this Sper requirements document.

Resistors and capacitors used in the design are selected from established reliability (ER) types. Life expectancy is increased by ensuring that all allowable stress levels are detected in accordance with SPAR-RMS-PA.003. All ceramic and electrolytic capacitors are routinely subjected to radiographic inspection in accordance with the requirements of MSFC-STD-355.

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The SPA board is fabricated using Surface Mount Technology (SMT). This is a PWB assembly technology in which the components a soldered to the solder pads on the surface of the PWB. The significant advantage of this technology is to enable the parts on the board to be more densely packed, to reduce to overall volume and weight of the assembly.

The assembly process is highly automated. The parts are mounted on the boards using a computer controlled "pick and place" machine. I subsequent soldering operation is performed using a belt furnace, in which the time and temperature thermal profile that the PWB assembly is exposed to is tightly controlled and optimized to ensure proper part soldering attachment. The assembly is manufactured under documented procedures and quality controls. These controls are exercised throughout the assembly, inspection, and testing of the unit. This inspection includes workmanship, component mounting, soldering, and conformal coating to ensure that it is in accordance with the NHB 5300 standard.

The SMT line used for the SPA PWB assembly has undergone a full qualification program, and assembles produced on this line are used other space programs.

The circuit board design has been reviewed to ensure adequate conductor width and separation and to confirm appropriate dimensions of solder pads and of component hold provisions. Parts mounting methods are controlled in accordance with MSFC-STD-154A, MSFC-STD-13 and SASD 2573751. These documents require approved mounting methods, stress relief and component security.

Test:

QUALIFICATION TESTS - The SPA is subjected to the following qualification feeting:

VtBRATION: Each axis of the QM is subjected to Flight Acceptance Vibration Test (FAVT), Qualification Acceptance Vibration Test (QAVT) and Qualification Vibration Tests (QVT) in accordance with the SPA Vibration Test Procedure (826588). The level and duration for FAVT is an per Figure 8 and Table 2 of 826586; the level and duration for QAVT is as per Figure 8 and Table of 826586. At the end of the three successive random vibration test in each axis, both directions (+/-) of each of the axis is subjected to a shock pulse test as per Figure 9 of 826586.

THERMALVACUUM: QM TVAC Test is in accordance with Figure 5 of the SPA TVAC Test Procedure (826568), with full Functional/Parametric Test performed at levels of +60 degrees C and -36 degrees C, and non-operating at -54 degrees C. The Qualification vacuum levels during TVAC is 1X10**-8 torr or less. The total test duration is 7 1/2 cycles. The QM SPA is subjected to a minimum of 1000 hours of life testing and 1000 power On-Off cycles.

EMC: The QM is subjected to EMC Testing (tests CE01/CE03, CE07, C301, CS02, CS05, RE02, RS02, and RS03) in accordance with the SPA EMC test Procedure (826477) based on MIL-STD-451A.

LINIT FLIGHT ACCEPTANCE TESTS - The FM SPA is subjected to the following acceptance resting:

VIBRATION: FM Acceptance Vibration Test (AVT) in accordance with the SPA Vibration Test Procedure (826586), with level and duration as per Figure 6 and Table 2 of 826586.

THERMAL/VACUUM. FM TVAC Test is in accordance with Figure 6 of the SPA TVAC Test Procedure (826588), with levels of +49 degrees of control of 1 1/2 cycles. The vacuum levels during Acceptance TVAC Test is 1X10**-5 term or less.

JOINT SRU TESTS - The SPA is tested as part of the joints (ambient and vibration tests only). The ambient ATP for the Shoulder Joint, Elbow Joint, and Wrist Joint are as par ATP.2001, ATP.2003, and ATP.2005 respectively. The vibration test for the Shoulder Joint, and Elbow or Wrist Joint are as per ATP.2002, ATP.2004 and ATP.2006 respectively. Through wire function, continuity and electrical isolation tests are performed per TP.283.

MECHANICAL ARM REASSEMBLY - The SPA's/Joints undergo a mechanical arm integration stage where electrical checks are performed per TP 2007.

MECHANICAL ARM TESTING - The outgoing split-arm is configured on the Strongback and the Manaputator Arm Checkout is performed per ATP.1932.

FUGHT CHECKOUT: PDRS OPS Checkout (all vehicles) JSC 16967.

Inspection:

Units are manufactured under documented quality controls. These controls are exercised throughout design procurement, planning, receiving, processing, fatnication, assembly, testing and shipping of the units. Mandatory inspection points are employed at various stages of fabrication, assembly, and test. Government source inspection is invoked at various control levels.

EEE parts inspection is performed as required by SPAR-RMS-PA.003. Each EEE part is qualified at the part level to the requirements of th applicable specification. All EEE parts are 100% screened and burned-in, as a minimum, as required by SPAR-RMS-PA.003, by the supplier. OPA is performed as required by PA.003 on a randomly selected 5% of parts, maximum 5 pieces, minimum 3 pieces for each lot number/date code of parts received. All cavity devices are subjected to 100% PIND. Whe is procured to specification MIL-W-22759 or MIL-W-81361 and inspected and tested to NASA JSCM8080 Standard Number 95A.

Receiving inspection verifies that all parts received are as identified in the procurement documents, that no physical damage has occurred to parts during shapment, that the receiving documents provide adequate traceability information and screening data clearly identifies acceptable carts.

Parts are inspected throughout manufacture and assembly as appropriate to the manufacturing stage completed. These inspections include:

Printed circuit board inspection for track separation, damage and adequacy of plated through hotes, component mounting inspection for correct soldering, wire looping, strepping, etc. Operators and inspections are trained and certified to NASA NHB 5300,4(3A-1) Standard.

Conformal coating inspection for adequate processing is performed using ultraviolet light techniques. P.C. Board installation inspection inclicates for correct board installation, alignment of boards, proper connector contact matting, wire routing, strapping of wires etc. Post P.C. Board installation includes cleanliness and workmanship (Spar/government rep. mandatory inspection point).

Prepared:

165ep96 by Fung, Bill

Supersedes: N/A

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Unit Pre-Acceptance Test Inspection, which includes an audit of lower tier Inspection completion, as built configuration verification to as design etc (mandatory inspection point). A unit Test Readinism Review (TRR) which includes verification of test personnel, test documents, test equipment calibration/validation status and hardware configuration is convenied by QA in conjunction with Engineering, Reliability, Configuration Control, Supplier as applicable, and the government representative, prior to the start of any formal testing (Acceptance or Qualification). Unit level Acceptance Testing (ATP) Inoludes ambient performance, thermal and vibration testing (Spar/government rep. mandatory inspection point).

Integration of unit to Joint SRU - Inspections include grounding checks, connectors for bent or pushback contacts, visual, cleanliness, interconnect wring and power up test to the appropriate Joint Inspection Test Procedure (ITP). Joint level Pre-Acceptance Test Inspection, includes an audit of lower tier inspection completion, as built configuration ventication to as design etc. Joint level Acceptance Testing (ATP) includes ambient and vibration leating (Sparigovernment rep. mandatory Inspection point).

Mechanical Arm Reassembly - the integration of mechanical arm subassemblies to form the assembled arm. Inspections are performed at each phase of integration which includes electrical checks, through winng checks, wiring routing, interface connectors for bent or pushback contacts atc. Mechanical Arm Testing - Strongback and flat floor ambient performance test (Spar/government rep. mandatory inspection point).

OMR80 Offline: Power-up arm. Verify no ABE communication failures or 8JTE errors.

OMRSD Online None.

installation:

OMRSD Online Power-up arm. Verity no ABE communication fallures or BITE errors.

Turnaround:

Screen Fallure: A: Pass

8: Pass C: Pass

Grew Training: The crew is trained to always observe whether the arm is responding properly to commends.

Crew Action: Select Direct Drive. Single/Direct Orive switch should be pulsed to maintain proper rates.

Operational Effect: Computer supported modes are lost. Direct Drive and Back-up are available.

Mission None.

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inctional Group	Name	Position	Téléphone	Date Signed	Status
geneer	Hiltz, Michael / SPAR-BRAMPTON	Systems Engineer	4634	Of Marais	Signed
- acatry	Molgaard, Lena / SPAR-BRAMPTON	Reliability Engineer	4590	06Mar98	Signed
ogram Management Offic	Rice, Craig / SPAR-BRAMPTON	Technical Program Manager	4892	06Mar98	Signed
asystem Manager	Glenn, George / JSC-ER	RMS Subsystem Manager	(281) 483-1516	30Mar98	Signed
chrical Manager	Allison, Ron / JSC-MV6	RMS Project Engineer JSC	(713) 483-4072	09Apr98	Signed
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